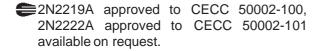
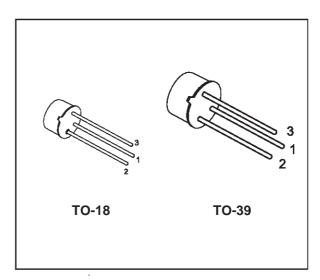


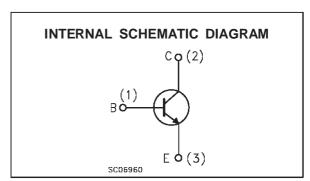
HIGH SPEED SWITCHES

DESCRIPTION

The 2N2219A and 2N2222A are silicon planar epitaxial NPN transistors in Jedec TO-39 (for 2N2219A) and in Jedec TO-18 (for 2N2222A) metal case. They are designed for high speed switching application at collector current up to 500mA, and feature useful current gain over a wide range of collector current, low leakage currents and low saturation voltage.







ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage (I _E = 0)	75	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	40	V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	6	V
Ic	Collector Current	0.8	Α
P _{tot}	Total Dissipation at $T_{amb} \le 25$ °C for 2N2219A for 2N2222A at $T_{case} \le 25$ °C for 2N2219A for 2N2222A	0.8 0.5 3 1.8	W W W
T _{stg}	Storage Temperature	-65 to 200	°C
Tj	Max. Operating Junction Temperature	175	°C

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THERMAL DATA

			TO-39	TO-18	
R _{thj-case}	Thermal Resistance Junction-Case	Max	50	83.3	°C/W
R _{thj-amb}	Thermal Resistance Junction-Ambient	Max	187.5	300	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ $^{\circ}C$ unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CBO}	Collector Cut-off Current (I _E = 0)	V _{CB} = 60 V V _{CB} = 60 V T _{case} = 150 °C			10 10	nA μA
I _{CEX}	Collector Cut-off Current (V _{BE} = -3V)	V _{CE} = 60 V			10	nA
I _{BEX}	Base Cut-off Current (V _{BE} = -3V)	V _{CE} = 60 V			20	nA
I _{EBO}	Emitter Cut-off Current (I _C = 0)	V _{EB} = 3 V			10	nA
V _{(BR)CBO} *	Collector-Base Breakdown Voltage (I _E = 0)	I _C = 10 μA	75			V
V _{(BR)CEO*}	Collector-Emitter Breakdown Voltage (I _B = 0)	I _C = 10 mA	40			V
V _{(BR)EBO} *	Emitter-Base Breakdown Voltage (I _C = 0)	Ι _Ε = 10 μΑ	6			V
$V_{CE(sat)}*$	Collector-Emitter Saturation Voltage	$I_{C} = 150 \text{ mA}$ $I_{B} = 15 \text{ mA}$ $I_{C} = 500 \text{ mA}$ $I_{B} = 50 \text{ mA}$			0.3 1	V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 150 mA I _B = 15 mA I _C = 500 mA I _B = 50 mA	0.6		1.2 2	V V
h _{FE} *	DC Current Gain	$\begin{array}{llllllllllllllllllllllllllllllllllll$	35 50 75 100 40 50		300	
h _{fe} *	Small Signal Current Gain	I _C = 1 mA V _{CE} = 10 V f = 1KHz I _C = 10 mA V _{CE} = 10 V f = 1KHz	50 75		300 375	
f _T	Transition Frequency	I _C = 20 mA V _{CE} = 20 V f = 100 MHz	300			MHz
Сево	Emitter Base Capacitance	I _C = 0 V _{EB} = 0.5 V f = 100KHz			25	pF
С _{СВО}	Collector Base Capacitance	I _E = 0 V _{CB} = 10 V f = 100 KHz			8	pF
R _{e(hie)}	Real Part of Input Impedance	I _C = 20 mA V _{CE} = 20 V f = 300MHz			60	Ω

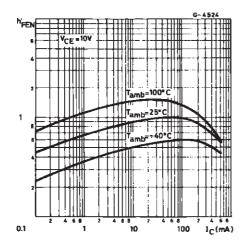
^{*} Pulsed: Pulse duration = 300 μs, duty cycle ≤ 1 %

ELECTRICAL CHARACTERISTICS (continued)

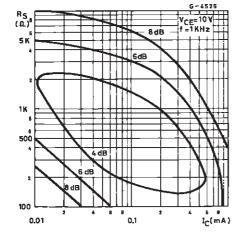
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
NF	Noise Figure	$I_C = 0.1 \text{ mA}$ $V_{CE} = 10 \text{ V}$ $f = 1 \text{KHz}$ $R_g = 1 \text{K}\Omega$		4		dB
h _{ie}	Input Impedance	I _C = 1 mA V _{CE} = 10 V I _C = 10 mA V _{CE} = 10 V	2 0.25		8 1.25	kΩ kΩ
h _{re}	Reverse Voltage Ratio	I _C = 1 mA V _{CE} = 10 V I _C = 10 mA V _{CE} = 10 V			8 4	10 ⁻⁴ 10 ⁻⁴
hoe	Output Admittance	I _C = 1 mA	5 25		35 200	μS μS
t _d **	Delay Time	$V_{CC} = 30 \text{ V}$ $I_{C} = 150 \text{ mA}$ $I_{B1} = 15 \text{ mA}$ $V_{BB} = -0.5 \text{ V}$			10	ns
t _r **	Rise Time	$V_{CC} = 30 \text{ V}$ $I_{C} = 150 \text{ mA}$ $I_{B1} = 15 \text{ mA}$ $V_{BB} = -0.5 \text{ V}$			25	ns
t _s **	Storage Time	$V_{CC} = 30 \text{ V}$ $I_{C} = 150 \text{ mA}$ $I_{B1} = -I_{B2} = 15 \text{ mA}$			225	ns
t _f **	Fall Time	$V_{CC} = 30 \text{ V}$ $I_{C} = 150 \text{ mA}$ $I_{B1} = -I_{B2} = 15 \text{ mA}$			60	ns
r _{bb} , C _b ,c	Feedback Time Constant	$I_C = 20 \text{ mA} V_{CE} = 20 \text{ V}$ f = 31.8MHz			150	ps

^{*} Pulsed: Pulse duration = 300 μs, duty cycle ≤ 1 % ** See test circuit

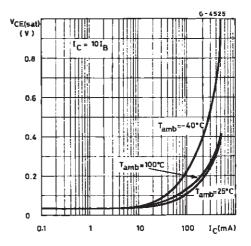
Normalized DC Current Gain.



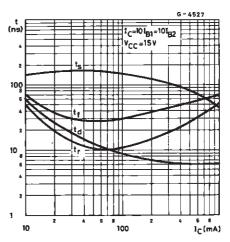
Contours of Constant Narrow Band Noise Figure.



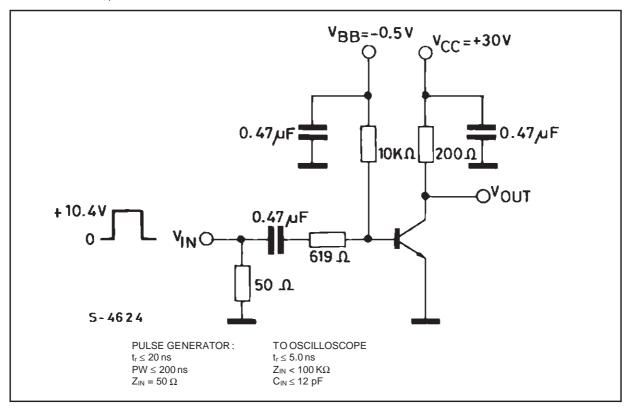
Collector-emitter Saturation Voltage.



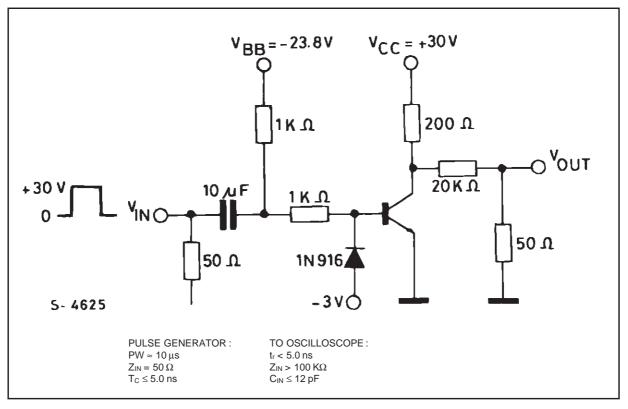
Switching Time vs. Collector Current.



Test Circuit fot td, tr.

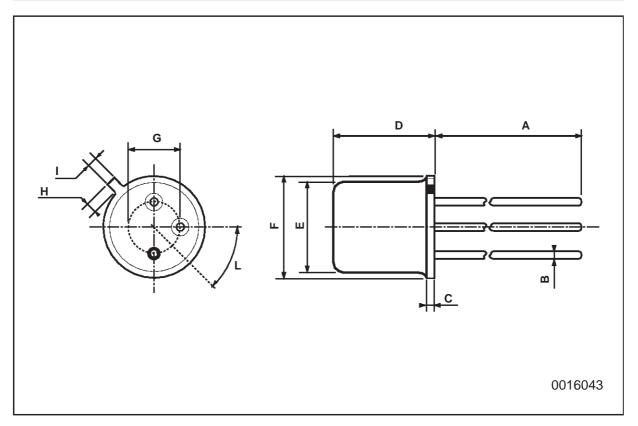


Test Circuit fot td, tr.



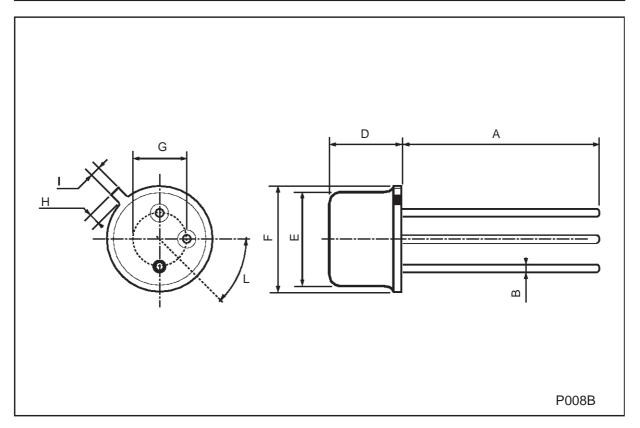
TO-18 MECHANICAL DATA

DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А		12.7			0.500		
В			0.49			0.019	
D			5.3			0.208	
E			4.9			0.193	
F			5.8			0.228	
G	2.54			0.100			
Н			1.2			0.047	
I			1.16			0.045	
L	45°			45°			



TO-39 MECHANICAL DATA

DIM.	mm			inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	12.7			0.500			
В			0.49			0.019	
D			6.6			0.260	
E			8.5			0.334	
F			9.4			0.370	
G	5.08			0.200			
Н			1.2			0.047	
I			0.9			0.035	
L	45° (typ.)						



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